

Absolute Maximum Ratings

Stresses beyond the limits listed below may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Input Voltage (V_{IN} , V_{PGOOD}).....	+3V
Enable Voltage (V_{EN}).....	$V_{IN} + 0.5V \leq 3V$
Storage Temperature.....	-65°C to +150°C
Junction Temperature.....	150°C
Lead Temperature (Soldering, 5 sec).....	260°C
ESD Rating (HBM - Human Body Model), All pins.....	2kV

Operating Conditions

Input Voltage Range (V_{IN} , V_{EN} , V_{PGOOD}).....	1.4V to 2.625V
Junction Temperature Range.....	-40°C to +125°C
Thermal Resistance (θ_{JA}) DFN10.....	40.5°C/W

Electrical Characteristics

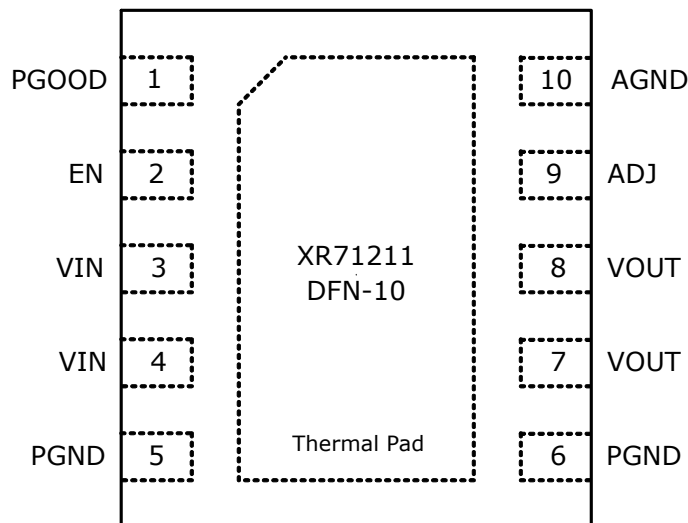
Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{IN} = V_{OUT} + 0.5V$, $I_{OUT} = 20\text{mA}$, $C_{IN} = 10\mu\text{F}$, $C_{OUT} = 22\mu\text{F}$. Limits applying over the full operating temperature range are denoted by a “•”

Symbol	Parameter	Conditions		Min	Typ	Max	Units
V_{IN}	Input Voltage Operating Range		•	1.4		2.625	V
I_{OUTMAX}	Maximum Output Current ^a		•	1.5			A
I_{GND}	Ground Current	EN active			2.0		mA
		EN active, $I_{OUT} = 1.5A$			2.5	3.5	mA
I_{SHDN}	Shutdown Current	$V_{EN}=0V$, $I_{OUT}=0mA$, $PGOOD$ Floating			12		μA
V_{ADJ}	ADJ Pin Voltage	$V_{IN} = 2.5V$, $V_{OUT} > 1V$		598.5	601.5	604.5	mV
			•	594.0		606.0	mV
		$V_{IN} = 1.8V$		597.0	600.0	603.0	mV
			•	592.0		605.0	mV
		$V_{IN} = 1.4V$		596.0	599.0	602.0	mV
			•	590.7		604.0	mV
V_{DROP}	Dropout Voltage	$I_{OUT} = 1.5A$, $V_{OUT} = 1.35V^b$	•			250	mV
R_{LOAD}	Output Voltage Load Regulation	$V_{IN} = V_{OUT} + 0.5V$, $20mA \leq I_{OUT} \leq 1.5A$				0.2	%
PSRR	Power Supply Rejection Ratio	$f > 300kHz$			30		dB
V_{NOISE}	Output Noise Voltage	10Hz to 100kHz			200		μV_{RMS}
I_{LIMIT}	Current Limit	$V_{OUT} = 0.9 \times V_{OUT(NOM)}$	•	1.6		3.2	A
	Reverse Bias Protection V_{OUT} Leakage Current	$V_{IN} = 0V$, $V_{OUT} = 2.625V$			-10		μA
	Thermal Shutdown Temperature				160		°C
	Thermal Shutdown Hysteresis				30		°C

Symbol	Parameter	Conditions		Min	Typ	Max	Units
	Startup Time	V _{OUT} = 1.0V			2		ms
	Power Good Threshold	V _{OUT} rising	•	92	94	97	% of V _{OUT}
	Power Good Threshold Hysteresis	V _{OUT} falling			2.8		% of V _{OUT}
	PGOOD Output Low	V _{IN} > 1.5V, I _{SINK} = 1mA	•			0.4	V
		V _{IN} > 1.4V, I _{SINK} = 200μA	•			0.4	V
Enable Pin							
	Enable Threshold Voltage	V _{EN} rising	•	0.43	0.55	0.67	V
	EN Sink Current	EN < V _{IN}			2.5		μA
		V _{IN} < EN < V _{IN} + 0.5V			15		μA
	Maximum Allowable EN Sink Current	EN = V _{IN} + 0.5V (with internal clamp)				100	μA
	EN Source Current	EN = 0V				10	μA

- a. The XR71211 is rated over a junction temperature range T_J of $-40^{\circ}C$ to $+125^{\circ}C$. For a given set of operating conditions, T_J has to be calculated in order to make sure it does not exceed maximum specification. Use equation $T_J = T_A + (P_D \times \theta_{JA})$ where θ_{JA} is the package thermal impedance, T_A is the ambient temperature and P_D is power dissipation. P_D is calculated from $P_D = (V_{IN} - V_{OUT}) \times I_{OUT}$
- b. Dropout voltage is defined as the input to output voltage differential ($V_{IN} - V_{OUT}$) where the input voltage is low enough to cause the output voltage to drop 2% from the nominal value.

Pin Configuration

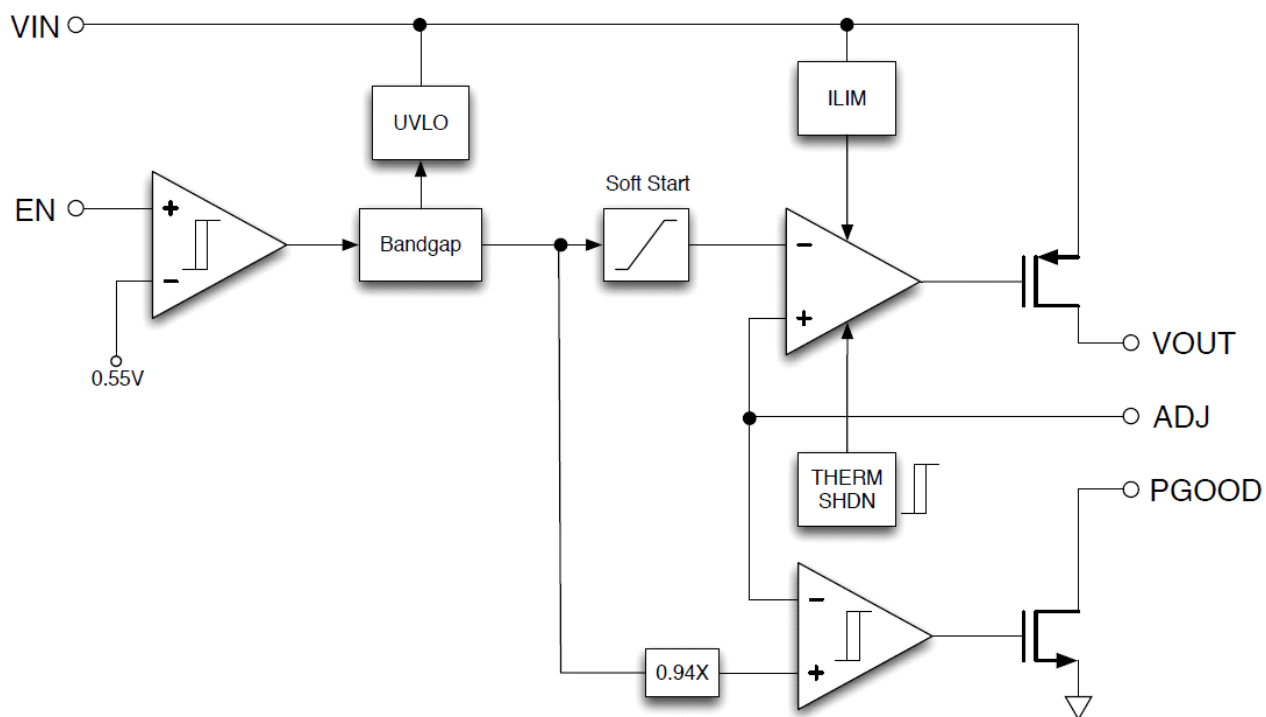


Pin Assignments

Pin No.	Pin Name	Type	Description
1	PGOOD	OD	Power Good open-drain output. When used it should be pulled up to VIN with a resistor. Typical resistor value is 100k Ω .
2	EN	I	Enable Input Pin. This is a high impedance MOS input with CMOS logic level compatibility. Logic high enables the device; logic low disables the device. EN must be asserted high after VIN reaches its minimum operating range. For automatic startup EN must be sequenced with respect to VIN as shown in application circuit. Do not pull this pin higher than VIN + 0.5V.
3, 4	VIN	PWR	Power Input Pin. Must be closely decoupled to PGND pin with a 4.7 μ F or greater ceramic capacitor.
5, 6	PGND	PWR	Power Ground
7, 8	VOUT	O	Regulator Output pin. Must be closely decoupled to PGND with a 4.7 μ F or greater ceramic capacitor.
9	ADJ	I	Adjustable Pin. Connect to a resistive voltage divider to set the output voltage of the device.
10	AGND	PWR	Signal ground. Connect with a separate trace to the ground of the output being regulated.
	Thermal Pad	PWR	Connect to PGND.

Type: I = Input, O = Output, I/O = Input/Output, PWR = Power, OD = Open-Drain

Functional Block Diagram



Typical Performance Characteristics

Unless otherwise noted: $V_{IN} = V_{OUT} + 0.5V$, $T_J = T_A = 25^\circ C$

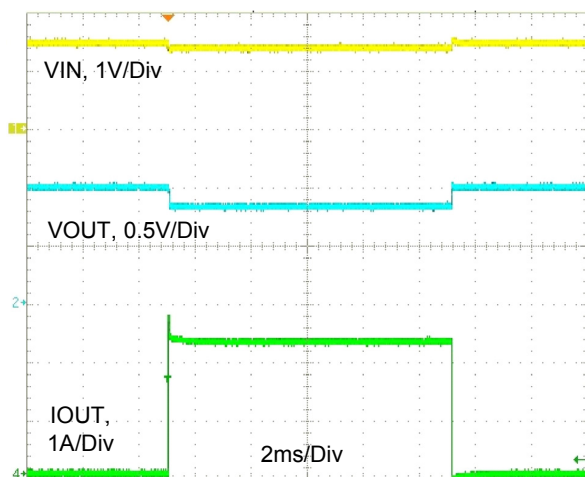


Figure 1: Current Limit, 1.5VIN, 1VOUT

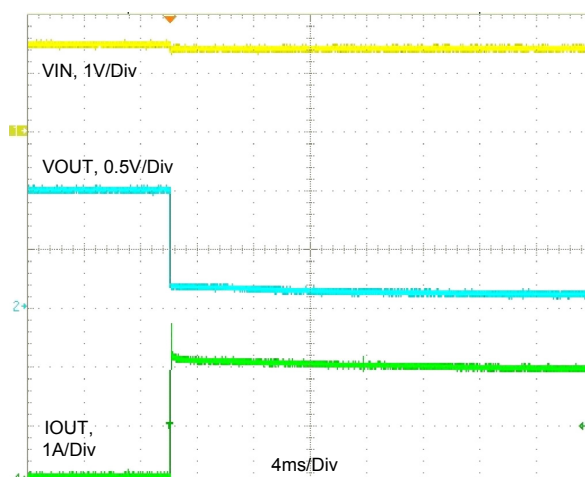


Figure 2: Short-circuit, 1.5VIN, 1VOUT

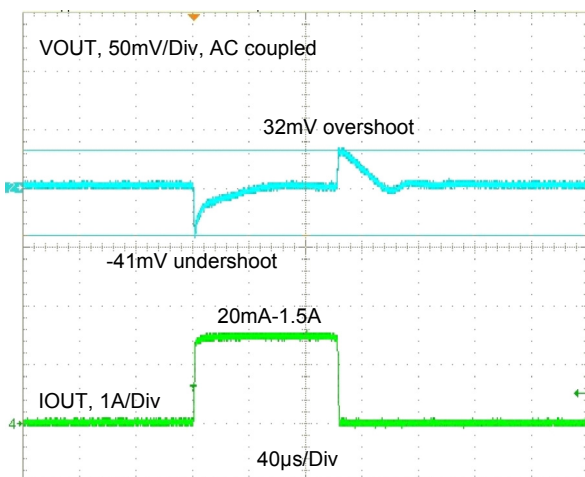


Figure 3: Transient Response, 20mA-1.5A, 1.5VIN, 1VOUT

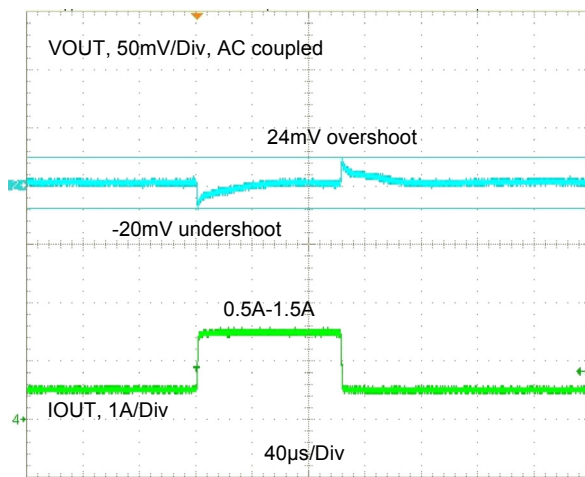


Figure 4: Transient Response, 0.5A-1.5A, 1.5VIN, 1VOUT

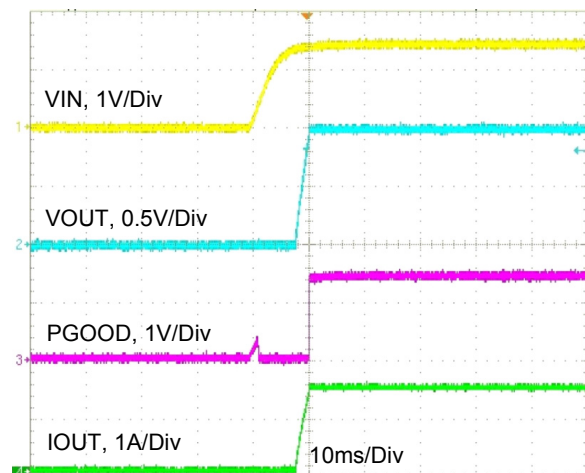


Figure 5: Powerup, IOUT=1.5A, 1.5VIN, 1VOUT

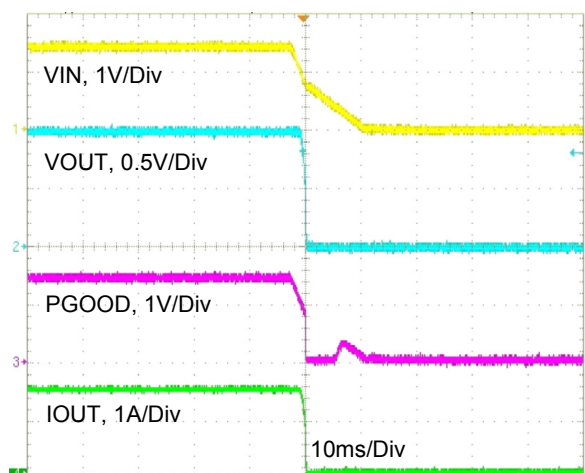


Figure 6: Powerdown, IOUT=1.5A, 1.5VIN, 1VOUT

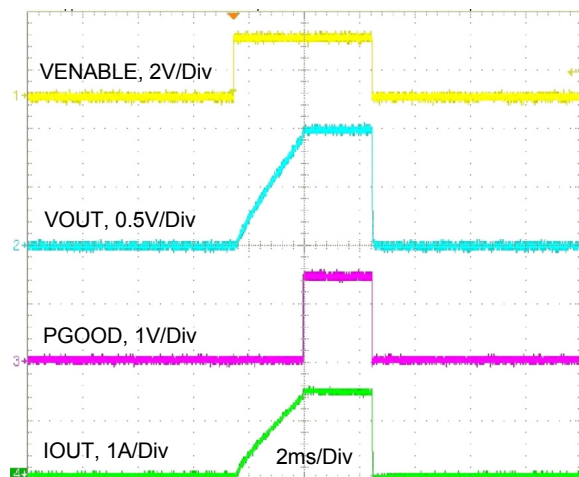


Figure 7: Enable Turn On/Off, 1.5A, 1.5VIN, 1VOUT

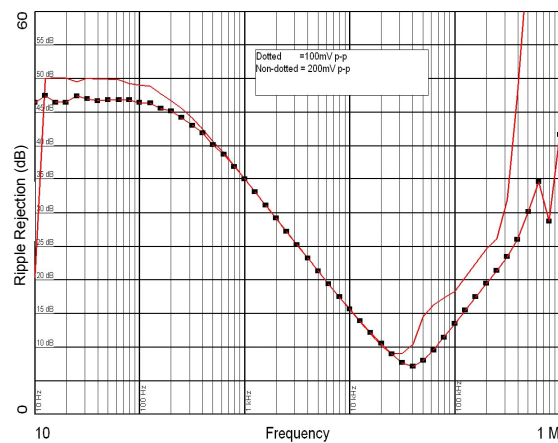


Figure 8: PSRR, 50mA, 1.5VIN, 1VOUT, 22 μ F COUT

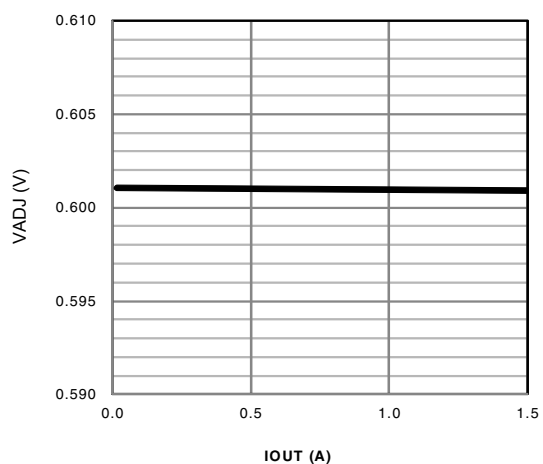


Figure 9: VADJ versus IOUT, 1.5VIN, 1VOUT

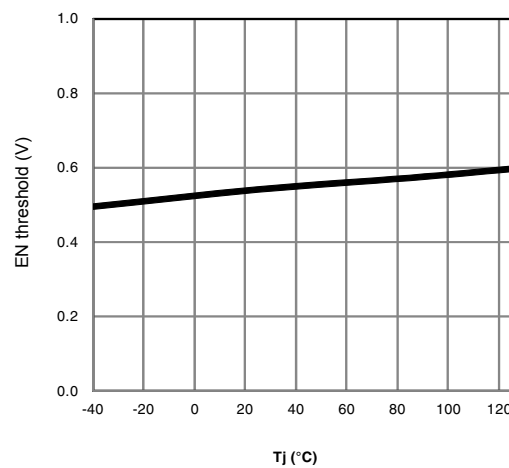


Figure 10: Enable Threshold versus Temperature

Functional Description

Single Rail Input Voltage

The XR71211's ultra low input voltage allows single rail operation from 2.625V down to 1.4V without requiring any extra biasing voltage. This single input voltage range provides easy conversions from industry standard 1.5V, 1.8V and 2.5V power rails.

Dropout Voltage

The dropout voltage is the input-to-output differential voltage at which the XR71211 ceases to regulate against further reductions in input voltage; this point occurs when the input voltage approaches the output voltage. The XR71211 provides a maximum of 250mV dropout voltage over full operating temperature range making it the perfect solution conversions requiring a 300mV differential between Vin and Vout. For example, 1.5Vin to 1.2Vout.

The maximum output current available for a given conversion is dependent on the operating conditions and thermal performance of DFN10/PCB. See note (a) on page 3.

Setting The Output Voltage

The XR71211 is an adjustable regulator that can be programmed to any value between 0.6V and 2.4V using 2 external resistors, R1 and R2. The relationship between the resistors and the output voltage is:

$$R_1 = R_2 \times \left(\frac{V_{OUT}}{0.6} - 1 \right)$$

where VOUT is the desired output voltage.

Sum of resistors R1 and R2 must meet the following requirement:

$$\frac{V_{OUT}}{R_1 + R_2} \geq 20mA$$

Input and Output Capacitors

The XR71211 is designed to be stable for all available types and values of output capacitors greater than 4.7μF.

The required capacitance on the VIN and VOUT pins strongly depends on the input supply source impedance; the minimum recommended capacitor for VIN is 4.7μF. Low ESR ceramic X5R and X7R capacitors are recommended

and should be placed as close as possible to the pins for optimal performance.

Because of the low voltages and high currents supported by this device, typical capacitance values of 10uF for input and 22uF for output are recommended when powering high speed digital circuits.

Enable Input and Shutdown

The enable pin (EN) can be used to shut down the XR71211. Connecting this pin to ground signal or to a voltage less than typical 0.55V will completely turn off the regulator. Pulling the EN above 0.67V enables the XR71211. Where EN is derived from VIN it must be sequenced with respect to VIN as shown in the application circuit. Where an independent control signal is applied to EN, it must be asserted high after VIN reaches its minimum operating range.

The enable pin is a high impedance MOS input. In order to allow the EN pin compatibility with 5V or 3.3V control signals, there is an internal clamp set to VIN+0.5V. When using the EN pin with a control signal greater than VIN+0.5V, a resistor must be placed in series with the EN pin to limit the input current below 100uA. The resistor must also be low enough to ensure at least 15uA can be sourced to enable the part.

The precision feature enables simple sequencing of multiple power supplies with a resistor divider from another power supply or power good flag. The EN pin can also be used as an external UVLO to disable the part when input voltage falls below a lower boundary of operation.

Soft Start

The XR71211 features a soft-start which controls the output voltage ramp and allows the regulator to gradually reach the initial steady state operating point. This reduces current spikes and surges at start up due to output capacitor inrush current. Internal sequencing completes in 50us, and then the reference voltage is linearly ramped over a period of approximately 2000us.

The inrush current will be the lesser of the current limit value or the current defined by the equation below:

$$I_{INRUSH} = C_{OUT} \times \frac{V_{OUT}}{2000\mu s}$$

Power Good Flag

The XR71211 features a Power Good Flag output signaling an abnormal operating condition. A low voltage on the Power Good Flag output indicates:

- Output voltage VOUT is approximately 9% below its expected value
- A thermal fault has occurred

The Power Good Flag output, is an open collector capable of sinking in excess of 1mA.

Output Current Limit Protection

The XR71211 integrates output current limit protection in order to protect the system main power supply, the regulator itself and the load from excessive current flow. This current limit effectively keeps the flow of current in the circuit at a safe level.

In short circuit conditions, the device will take additional steps to limit input and power by disabling and re-enabling the pass device until the short condition is removed and normal operation can resume. Depending on the impedance of the short, this short circuit protection function may initiate operation between 10% and 50% of the targeted output voltage.

Thermal Protection and Shutdown

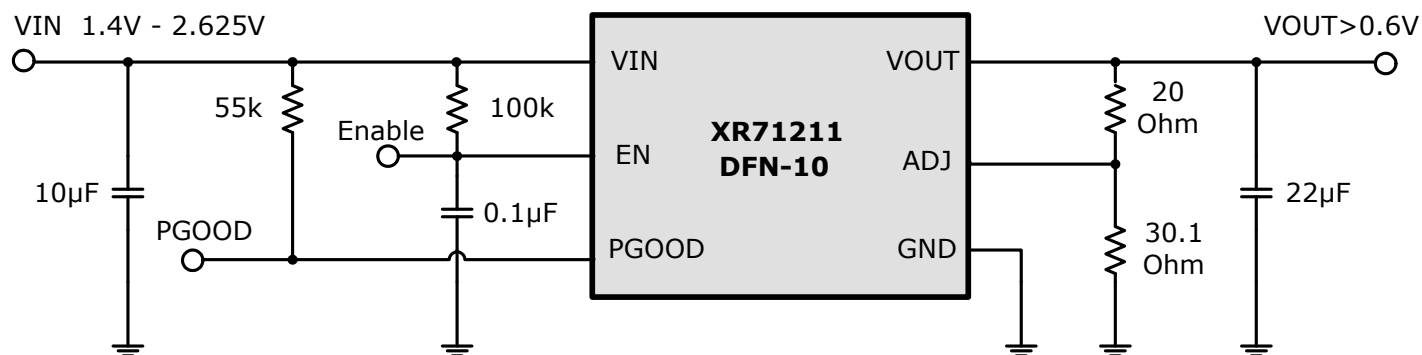
The XR71211 includes a thermal shutdown circuitry in order to restrict the device's operating temperature within a safe operating range. When activated, typically at 160°C, the XR71211 is forced into a low power reset state with a typical hysteresis of 30°C.

Combined with the short circuit current protection, it reduces and limits the heating effects of over-temperature and/or over-current conditions on the LDO and surrounding circuits.

Reverse Bias Protection

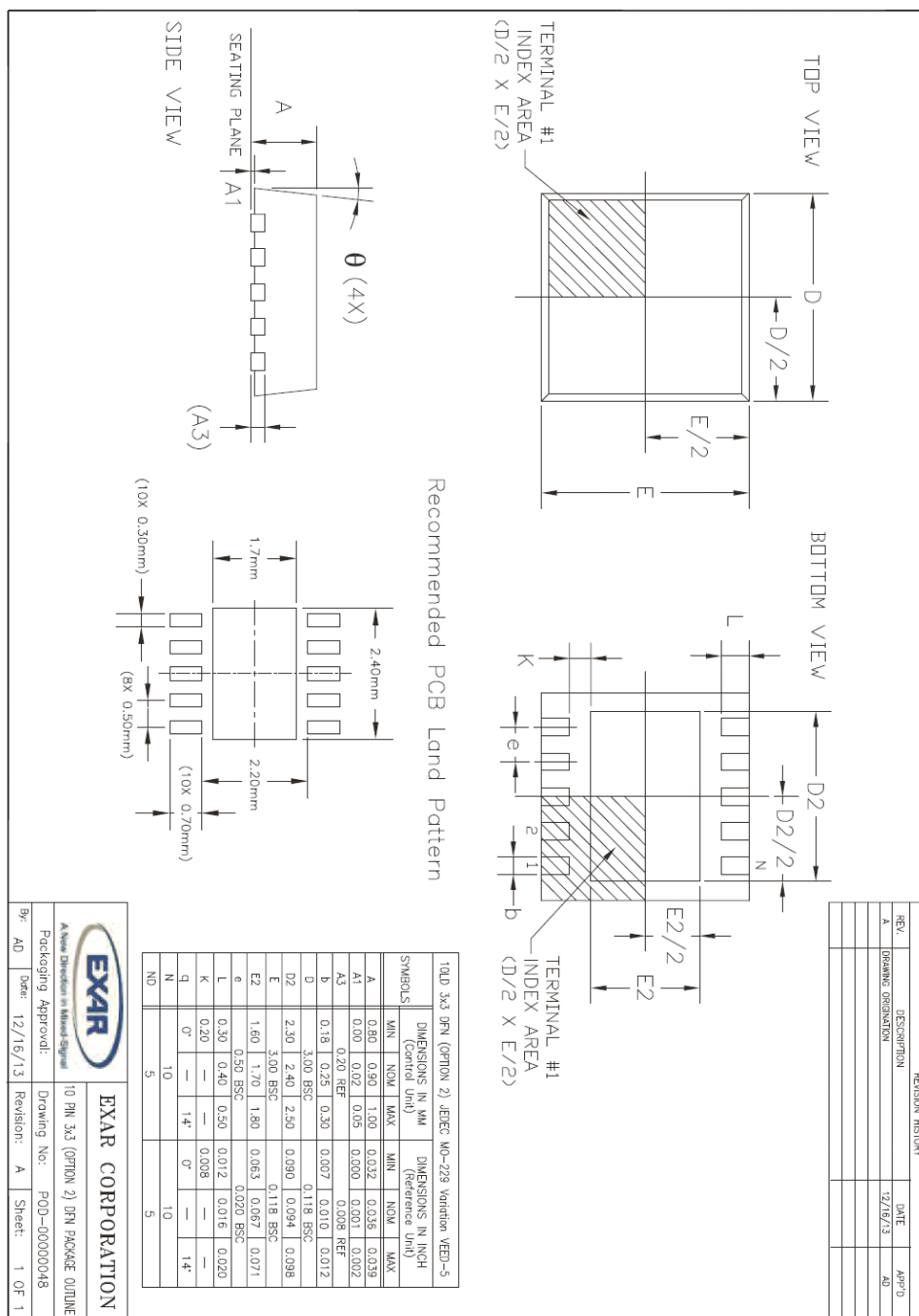
In addition to the standard protection features in these devices, they also incorporate a reverse bias protection. Most LDOs have a parasitic body diode that provides a path from VOUT to VIN if the input is shorted to ground. The XR71211 has a blocking diode to ensure that no high discharge currents can occur between the output and the input when the input is shorted to ground.

Application Circuit



Mechanical Dimensions

10-Pin DFN



Ordering Information

Part Number	Package	Green	Operating Temperature Range	Packaging Quantity	Marking
XR71211EH-F	10-pin DFN	Yes	-40°C to +125°C	Bulk	71211
XR71211EHMTR-F	10-pin DFN	Yes	-40°C to +125°C	250 / Reel	71211
XR71211EHTR-F	10-pin DFN	Yes	-40°C to +125°C	3000 / Reel	71211
XR71211EVB	Evaluation Board	N/A	N/A	N/A	N/A

Revision History

Revision	Date	Description
1A	May 2014	Initial release
1B	September 2014	Added to EN pin description, added to Enable Input Functional Description ECN 1440-05

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A New Direction in Mixed-Signal

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